

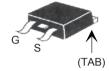
PolarHT[™] Power MOSFET

IXTA 75N10P IXTP 75N10P IXTQ 75N10P V_{DSS} = 100 V I_{D25} = 75 A $R_{DS(on)}$ ≤ 25 mΩ

N-Channel Enhancement Mode Avalanche Rated

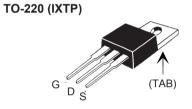


TO-263 (IXTA)

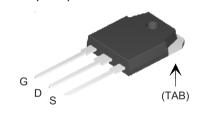


Symbol	Test Conditions	Maximum Ratings		
V _{DSS} V _{DGR}	$T_J = 25^{\circ}$ C to 175° C $T_J = 25^{\circ}$ C to 175° C; $R_{GS} = 1$ MΩ	100 100	V	
V_{gs}	Continuous	<u>+2</u> 0	V	
V _{GSM}	Transient	±30	V	
I _{D25}	T _C =25°C	75	Α	
I _{DM}	$T_{_{\rm C}}$ = 25° C, pulse width limited by $T_{_{\rm JM}}$	200	Α	
I _{AR}	T _C =25°C	50	Α	
E _{AR}	T _C =25°C	30	mJ	
E _{AS}	T _C = 25° C	1.0	J	
dv/dt	$I_{S} \leq I_{DM}, \text{ di/dt} \leq 100 \text{ A/}\mu\text{s}, V_{DD} \leq V_{DSS}, \\ T_{J} \leq 150^{\circ}\text{ C}, R_{G} = 10 \Omega$	10	V/ns	
P_{D}	T _C =25°C	360	W	
T _J T _{JM} T _{stg}		-55 +175 175 -55 +175	°C °C °C	
T _L T _{SOLD}	1.6 mm (0.062 in.) from case for 10 s Plastic body for 10 s	300 260	°C °C	
M _d	Mounting torque (TO-3P / TO-220)	1.13/10	Nm/lb.in.	
Weight	TO-3P TO-220 TO-263	5.5 4 3	g g g	





TO-3P (IXTQ)



G = Gate	D = Drain
S = Source	TAB = Drain

Features

- ¹ International standard packages
- ¹ Unclamped Inductive Switching (UIS) rated
- Low package inductance
 - easy to drive and to protect

Advantages

- ^I Easy to mount
- Space savings
- High power density

Symbol (T _J = 25° C, t	Test Conditions unless otherwise specified)		Ch Min.		istic Va Max	
BV _{DSS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		100			V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		3.0		5.5	V
I _{GSS}	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$				±100	nA
I _{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	T _J = 125° C			25 250	μ Α μ Α
R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_{D} = 0.5 I_{D25}$ Pulse test, t \le 300 \mus, duty (cycle d ≤ 2 %		21	25	mΩ

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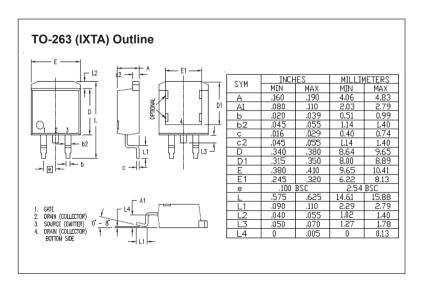


Symbol **Test Conditions Characteristic Values** (T₁ = 25° C, unless otherwise specified) Min. Typ. Max. $V_{DS} = 10 \text{ V}; I_{D} = 0.5 I_{D25}, \text{ pulse test}$ 20 28 S $\boldsymbol{g}_{\mathsf{fs}}$ Ciss 2250 рF $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ 890 рF 275 pF Crss $\mathbf{t}_{\text{d(on)}}$ 27 ns V_{GS} = 10 V, V_{DS} = 0.5 V_{DSS} , I_{D} = 0.5 I_{D25} 53 t, ns $R_c = 10 \Omega (External)$ 66 ns $\mathbf{t}_{\mathsf{d(off)}}$ 45 t, ns $\boldsymbol{\mathsf{Q}_{\mathsf{g(on)}}}$ 74 nC \mathbf{Q}_{gs} V_{GS} = 10 V, V_{DS} = 0.5 V_{DSS} , I_{D} = 0.5 I_{D25} 18 nC $\mathbf{Q}_{\underline{g}\underline{d}}$ 40 nC $\mathbf{R}_{\mathrm{thJC}}$ 0.42°C/W $\mathbf{R}_{\mathrm{thCK}}$ °C/W (TO-3P) 0.21 (TO-220) 0.25 $^{\circ}$ C/W

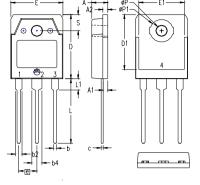
Source-Drain Diode

Characteristic Values (T₁ = 25° C, unless otherwise specified)

Symbol	Test Conditions	Min.	Тур.	Max.	
I _s	V _{GS} = 0 V			75	Α
I _{sm}	Repetitive			200	Α
V _{SD}	$I_F = I_S$, $V_{GS} = 0$ V, Pulse test, t ≤300 µs, duty cycle d≤ 2 %			1.5	V
t _{rr}	I _F = 25 A -di/dt = 100 A/μs		120		ns
\mathbf{Q}_{RM}	V _R = 50 V		2.0		μС



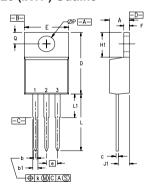
TO-3P (IXTQ) Outline



1 – GATE 2 – DRAIN (COLLECTOR) 3 – SOURCE (EMITTER) 4 – DRAIN (COLLECTOR)

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
Α	.185	.193	4.70	4.90
A1	.051	.059	1.30	1.50
A2	.057	.065	1.45	1.65
Ь	.035	.045	0.90	1.15
b2	.075	.087	1.90	2.20
b4	.114	.126	2.90	3.20
С	.022	.031	0.55	0.80
D	.780	.799	19.80	20.30
D1	.665	.677	16.90	17.20
E	.610	.622	15.50	15.80
E1	.531	.539	13.50	13.70
е	.215 BSC		5.45	BSC
L	.779	.795	19.80	20.20
L1	.134	.142	3.40	3.60
ØΡ	.126	.134	3.20	3.40
ØP1	.272	.280	6.90	7.10
S	.193	.201	4.90	5.10

TO-220 (IXTP) Outline



Pins: 1 - Gate 2 - Drain 3 - Source 4 - Drain

SYM	INCHES		MILLIMETERS		
2 I M	MIN	MAX	MIN	MAX	
Α	.170	.190	4.32	4.83	
Ь	.025	.040	0.64	1.02	
b1	.045	.065	1.15	1.65	
С	.014	.022	0.35	0.56	
D	.580	.630	14.73	16.00	
E	.390	.420	9.91	10.66	
е	.100 BSC		2.54 BSC		
F	.045	.055	1.14	1.40	
H1	.230	.270	5.85	6.85	
J1	.090	.110	2.29	2.79	
k	0	.015	0	0.38	
L	.500	.550	12.70	13.97	
L1	.110	.230	2.79	5.84	
ØΡ	.139	.161	3.53	4.08	
Q	.100	.125	2.54	3.18	

IXYS reserves the right to change limits, test conditions, and dimensions.



Fig. 1. Output Characteristics

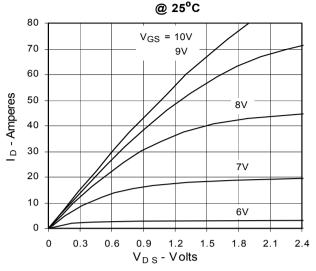


Fig. 3. Output Characteristics @ 125°C

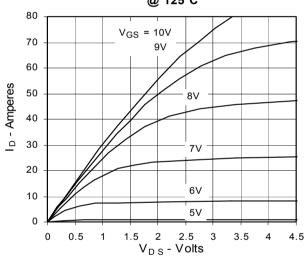


Fig. 5. $R_{DS(on)}$ Normalized to 0.5 I_{D25} Value vs. I_{D}

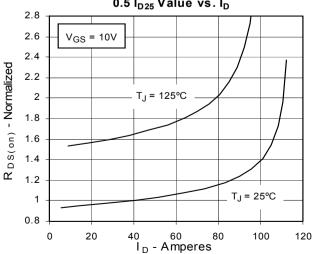


Fig. 2. Extended Output Characteristics
@ 25°C

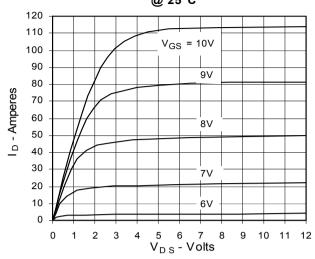


Fig. 4. $R_{DS(on)}$ Normalized to 0.5 I_{D25} Value vs. Junction Temperature

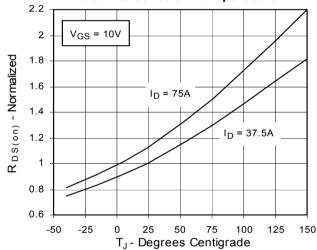


Fig. 6. Drain Current vs. Case
Temperature

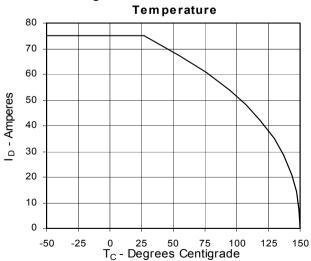
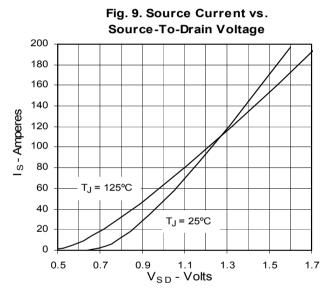
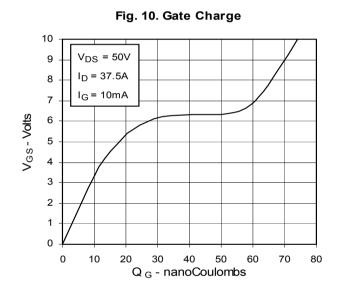
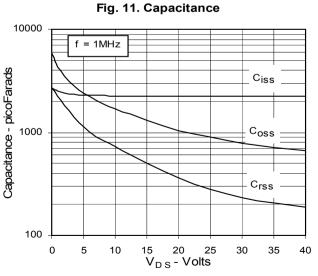


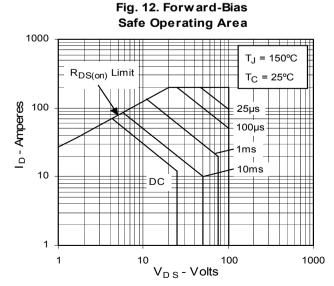
Fig. 7. Input Admittance D - Amperes 125°C 25°C -40°C V_{GS} - Volts

Fig. 8. Transconductance $T_J = -40^{\circ}C$ g fs - Siemens 25°C 125°C O 100 120 I_D - Amperes



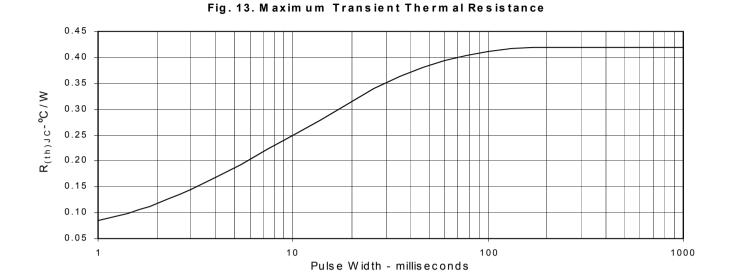






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